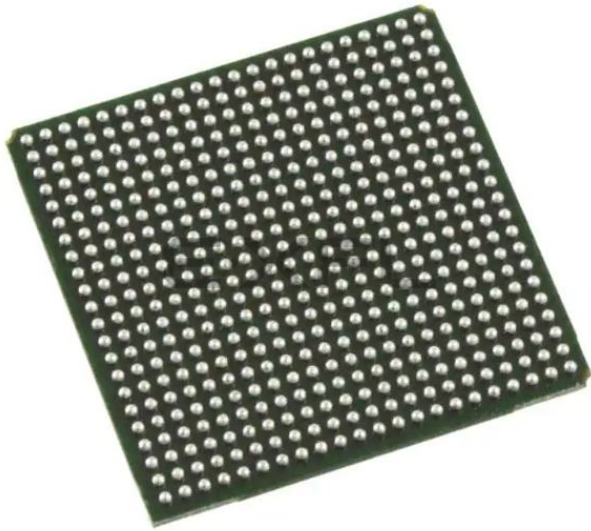




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-5f484c

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

LatticeECP2M Supply Current (Standby)^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2M20	25	mA
		ECP2M35	50	mA
		ECP2M50	85	mA
		ECP2M70	100	mA
		ECP2M100	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	24	mA
		ECP2M35	24	mA
		ECP2M50	24	mA
		ECP2M70	24	mA
		ECP2M100	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	GPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2M20	2	mA
		ECP2M35	2	mA
		ECP2M50	2	mA
		ECP2M70	2	mA
		ECP2M100	2	mA
I_{CCJ}	V_{CCJ} Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

3. Frequency 0MHz.

4. Pattern represents a "blank" configuration data file.

5. $T_J = 25^{\circ}\text{C}$, power supplies at normal voltage.

LatticeECP2/M External Switching Characteristics⁹

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL) ¹									
t _{CO}	Clock to Output - PIO Output Register	LFE2-6	—	3.50	—	3.90	—	4.20	ns
		LFE2-12	—	3.50	—	3.90	—	4.20	ns
		LFE2-20	—	3.50	—	3.90	—	4.20	ns
		LFE2-35	—	3.50	—	3.90	—	4.20	ns
		LFE2-50	—	3.50	—	3.90	—	4.20	ns
		LFE2-70	—	3.70	—	4.10	—	4.40	ns
		LFE2M20	—	3.90	—	4.30	—	4.70	ns
		LFE2M35	—	3.90	—	4.30	—	4.70	ns
		LFE2M50	—	4.50	—	5.00	—	5.40	ns
		LFE2M70	—	4.50	—	5.00	—	5.40	ns
		LFE2M100	—	4.50	—	5.00	—	5.40	ns
t _{SU}	Clock to Data Setup - PIO Input Register	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
t _H	Clock to Data Hold - PIO Input Register	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.80	—	2.10	—	2.30	—	ns
		LFE2M70	1.80	—	2.10	—	2.30	—	ns
		LFE2M100	1.80	—	2.10	—	2.30	—	ns

Table 3-13. Periodic Receiver Jitter Tolerance Specification¹

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Periodic	3.125 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	2.5 Gbps	600 mV differential eye	—	—	0.22	UI, p-p
	1.25 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	250 Mbps ²	600 mV differential eye	—	—	0.08	UI, p-p

1. Values are measured with PRBS 2⁷-1, all channels operating.

2. Jitter specification is limited by measurement equipment capability.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M8	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
P7	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
R8	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
VCCIO	VCCIO4	4			VCCIO4	4		
T5	PB14A	4	BDQ15	T	PB32A	4	BDQ33	T
T6	PB14B	4	BDQ15	C	PB32B	4	BDQ33	C
T8	PB15A	4	BDQS15	T	PB33A	4	BDQS33	T
GND	GNDIO4	-			GNDIO4	-		
R7	PB16A	4	BDQ15	T	PB34A	4	BDQ33	T
T9	PB15B	4	BDQ15	C	PB33B	4	BDQ33	C
T7	PB16B	4	BDQ15	C	PB34B	4	BDQ33	C
L8	PB17A	4	BDQ15	T	PB35A	4	BDQ33	T
VCCIO	VCCIO4	4			VCCIO4	4		
P8	PB18A	4	BDQ15	T	PB36A	4	BDQ33	T
L9	PB17B	4	BDQ15	C	PB35B	4	BDQ33	C
N8	PB18B	4	BDQ15	C	PB36B	4	BDQ33	C
R9	PB19A	4	BDQ15	T	PB37A	4	BDQ33	T
GND	GNDIO4	-			GNDIO4	-		
R10	PB19B	4	BDQ15	C	PB37B	4	BDQ33	C
-	-	-			VCCIO	4		
-	-	-			GNDIO4	4		
N9	PB20A	4	BDQ24	T	PB47A	4	BDQ51	T
T10	PB21A	4	BDQ24	T	PB48A	4	BDQ51	T
M9	PB20B	4	BDQ24	C	PB47B	4	BDQ51	C
R11	PB21B	4	BDQ24	C	PB48B	4	BDQ51	C
P10	PB22A	4	BDQ24	T	PB49A	4	BDQ51	T
N11	PB23A	4	BDQ24	T	PB50A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
N10	PB22B	4	BDQ24	C	PB49B	4	BDQ51	C
P11	PB23B	4	BDQ24	C	PB50B	4	BDQ51	C
T11	PB24A	4	BDQS24	T	PB51A	4	BDQS51	T
GND	GNDIO4	-			GNDIO4	-		
M11	PB25A	4	BDQ24	T	PB52A	4	BDQ51	T
T12	PB24B	4	BDQ24	C	PB51B	4	BDQ51	C
L11	PB25B	4	BDQ24	C	PB52B	4	BDQ51	C
T13	PB26A	4	BDQ24	T	PB53A	4	BDQ51	T
R13	PB27A	4	BDQ24	T	PB54A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
T14	PB26B	4	BDQ24	C	PB53B	4	BDQ51	C
P13	PB27B	4	BDQ24	C	PB54B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
N12	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
M12	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
R15	CFG2	8			CFG2	8		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C3	C3	PL2A	7	VREF2_7	T (LVDS)*
C2	C2	PL2B	7	VREF1_7	C (LVDS)*
VCCIO	VCCIO	VCCIO7	7		
-	GND	GNDIO7	7		
D3	D3	PL7A	7	LDQ8	T
D4	D4	PL6A	7	LDQ8	T (LVDS)*
D2	D2	PL7B	7	LDQ8	C
GND	GND	GNDIO7	-		
E4	E4	PL6B	7	LDQ8	C (LVDS)*
B1	B1	PL13A	7	LDQ16	T
C1	C1	PL13B	7	LDQ16	C
F5	F5	PL15A	7	LDQ16	T
VCCIO	VCC	VCCIO	7		
F4	F4	PL14A	7	LDQ16	T (LVDS)*
G6	G6	PL15B	7	LDQ16	C
G4	G4	PL14B	7	LDQ16	C (LVDS)*
D1	D1	PL16A	7	LDQS16	T (LVDS)*
GND	GND	GNDIO7	-		
E1	E1	PL16B	7	LDQ16	C (LVDS)*
F3	F3	PL17A	7	LDQ16	T
G3	G3	PL17B	7	LDQ16	C
VCCIO	VCCIO	VCCIO7	7		
F2	F2	PL18A	7	LDQ16	T (LVDS)*
F1	F1	PL18B	7	LDQ16	C (LVDS)*
GND	GND	GNDIO7	-		
G2	G2	PL19A	7	PCLKT7_0/LDQ16	T
G1	G1	PL19B	7	PCLKC7_0/LDQ16	C
H6	H6	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO	VCCIO6	6		
H5	H5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
H4	H4	PL22A	6	VREF2_6/LDQ25	T
GND	GND	GNDIO6	-		
H3	H3	PL22B	6	VREF1_6/LDQ25	C
H2	H2	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
H1	H1	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
G10	G10	VCC	-		
J4	J4	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
J5	J5	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
J6	J6	LLM0_PLLCAP	6		
K4	K4	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*
GND	GND	GNDIO6	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U1	NC	-			PL34A	6	LDQ31	T
V1	NC	-			PL34B	6	LDQ31	C
GND	GNDIO6	-			GNDIO6	-		
P3	NC	-			NC	-		
R3	NC	-			NC	-		
R4	NC	-			NC	-		
U2	NC	-			NC	-		
VCCIO	VCCIO6	6			VCCIO6	6		
V2	NC	-			NC	-		
W2	NC	-			NC	-		
T6	NC	-			PL38A	6	LDQ39	T
R5	NC	-			PL38B	6	LDQ39	C
GND	GNDIO6	-			GNDIO6	-		
R6	PL25A	6	LDQS25***	T (LVDS)*	PL39A	6	LDQS39***	T (LVDS)*
R7	PL25B	6	LDQ25	C (LVDS)*	PL39B	6	LDQ39	C (LVDS)*
W1	PL26A	6	LDQ25	T	PL40A	6	LDQ39	T
VCCIO	VCCIO6	6			VCCIO6	6		
Y2	PL26B	6	LDQ25	C	PL40B	6	LDQ39	C
Y1	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	PL41A	6	LLM0_GDLLT_IN_A**/LDQ39	T (LVDS)*
AA2	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	PL41B	6	LLM0_GDLLC_IN_A**/LDQ39	C (LVDS)*
T5	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T	PL42A	6	LLM0_GDLLT_FB_A/LDQ39	T
GND	GNDIO6	-			GNDIO6	-		
T7	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C	PL42B	6	LLM0_GDLLC_FB_A/LDQ39	C
R8	VCC	6			VCCPLL	6		
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
U3	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	PL44A	6	LLM0_GPLLT_IN_A**/LDQ48	T (LVDS)*
U4	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	PL44B	6	LLM0_GPLLC_IN_A**/LDQ48	C (LVDS)*
V3	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	PL45A	6	LLM0_GPLLT_FB_A/LDQ48	T
U5	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	PL45B	6	LLM0_GPLLC_FB_A/LDQ48	C
V4	PL32A	6	LDQ34	T (LVDS)*	PL46A	6	LDQ48	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
V5	PL32B	6	LDQ34	C (LVDS)*	PL46B	6	LDQ48	C (LVDS)*
Y3	PL33A	6	LDQ34	T	PL47A	6	LDQ48	T
Y4	PL33B	6	LDQ34	C	PL47B	6	LDQ48	C
W3	PL34A	6	LDQS34	T (LVDS)*	PL48A	6	LDQS48	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
W4	PL34B	6	LDQ34	C (LVDS)*	PL48B	6	LDQ48	C (LVDS)*
AA1	PL35A	6	LDQ34	T	PL49A	6	LDQ48	T
AB1	PL35B	6	LDQ34	C	PL49B	6	LDQ48	C
VCCIO	VCCIO6	6			VCCIO6	6		
U8	PL36A	6	LDQ34	T (LVDS)*	PL50A	6	LDQ48	T (LVDS)*
U7	PL36B	6	LDQ34	C (LVDS)*	PL50B	6	LDQ48	C (LVDS)*
V8	PL37A	6	LDQ34	T	PL51A	6	LDQ48	T
U6	PL37B	6	LDQ34	C	PL51B	6	LDQ48	C
GND	GNDIO6	-			GNDIO6	-		
W6	PL38A	6	LDQ42	T (LVDS)*	PL52A	6	LDQ56	T (LVDS)*

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K1	PL27B	7	LDQ29	C (LVDS)*
K5	PL28A	7	LDQ29	T
K7	PL28B	7	LDQ29	C
GND	GNDIO7	-		
K4	PL29A	7	LDQS29	T (LVDS)*
K3	PL29B	7	LDQ29	C (LVDS)*
L8	PL30A	7	LDQ29	T
VCCIO	VCCIO7	7		
L6	PL30B	7	LDQ29	C
L2	PL31A	7	LDQ29	T (LVDS)*
L1	PL31B	7	LDQ29	C (LVDS)*
L7	PL32A	7	LDQ29	T
GND	GNDIO7	-		
L5	PL32B	7	LDQ29	C
L4	PL33A	7	LDQ37	T (LVDS)*
L3	PL33B	7	LDQ37	C (LVDS)*
M8	PL34A	7	LDQ37	T
M6	PL34B	7	LDQ37	C
VCCIO	VCCIO7	7		
M2	PL35A	7	LDQ37	T (LVDS)*
M1	PL35B	7	LDQ37	C (LVDS)*
M7	PL36A	7	LDQ37	T
M5	PL36B	7	LDQ37	C
GND	GNDIO7	-		
M4	PL37A	7	LDQS37	T (LVDS)*
M3	PL37B	7	LDQ37	C (LVDS)*
N6	PL38A	7	LUM0_SPLLT_IN_A/LDQ37	T
VCCIO	VCCIO7	7		
N8	PL38B	7	LUM0_SPLLC_IN_A/LDQ37	C
N5	PL39A	7	LUM0_SPLLT_FB_A/LDQ37	T
N7	PL39B	7	LUM0_SPLLC_FB_A/LDQ37	C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
T9	PL50A	7	LDQ54	
R9	PL51A	7	LDQ54	T
P7	PL51B	7	LDQ54	C
VCCIO	VCCIO7	7		
N2	PL52A	7	LDQ54	T (LVDS)*
N1	PL52B	7	LDQ54	C (LVDS)*
P6	PL53A	7	LDQ54	T
P5	PL53B	7	LDQ54	C
GND	GNDIO7	-		
P4	PL54A	7	LDQS54	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AH24	PB89A	4	BDQ87	T
AH25	PB89B	4	BDQ87	C
VCCIO	VCCIO4	4		
AJ26	PB90A	4	BDQ87	T
AK26	PB90B	4	BDQ87	C
AF25	PB91A	4	BDQ87	T
AG25	PB91B	4	BDQ87	C
GND	GNDIO4	-		
AK22	PB92A	4	BDQ96	T
AJ22	PB92B	4	BDQ96	C
AE22	PB93A	4	BDQ96	T
AF22	PB93B	4	BDQ96	C
AG22	PB94A	4	BDQ96	T
VCCIO	VCCIO4	4		
AH22	PB94B	4	BDQ96	C
AG24	PB95A	4	BDQ96	T
AG23	PB95B	4	BDQ96	C
AE23	PB96A	4	BDQS96	
GND	GNDIO4	-		
AC22	PB97A	4	BDQ96	
AJ23	PB98A	4	BDQ96	T
VCCIO	VCCIO4	4		
AK23	PB98B	4	BDQ96	C
AD24	PB99A	4	BDQ96	T
AF24	PB99B	4	BDQ96	C
AC23	PB100A	4	VREF2_4/BDQ96	T
GND	GNDIO4	-		
AE24	PB100B	4	VREF1_4/BDQ96	C
AE25	CFG2	8		
AB22	CFG1	8		
AE26	CFG0	8		
AA22	PROGRAMN	8		
AD25	CCLK	8		
AD26	INITN	8		
AC24	DONE	8		
GND	GNDIO4	-		
AC25	PR90B	8	WRITEN	C
AE27	PR90A	8	CS1N	T
AC26	PR89B	8	CSN	C
AE28	PR89A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8		
AD27	PR88B	8	D1	C
AD28	PR88A	8	D2	T

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
W19	NC	-		
W18	NC	-		
V17	NC	-		
V18	NC	-		
D15	NC	-		
G14	NC	-		
G15	NC	-		
D14	NC	-		
E15	NC	-		
E14	NC	-		
F15	NC	-		
F14	NC	-		
F13	NC	-		
G12	NC	-		
G13	NC	-		
H8	VCCPLL	-		
H15	VCCPLL	-		
R8	VCCPLL	-		
R15	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO7	-			GNDIO7	-			
K5	PL23A	7	LDQS23	T (LVDS)*	PL27A	7	LDQS27	T*	
L5	PL23B	7	LDQ23	C (LVDS)*	PL27B	7	LDQ27	C*	
K4	PL24A	7	LDQ23	T	PL28A	7	LDQ27	T	
VCCIO	VCCIO7	7			VCCIO7	7			
L4	PL24B	7	LDQ23	C	PL28B	7	LDQ27	C	
K3	PL25A	7	LDQ23	T (LVDS)*	PL29A	7	LDQ27	T*	
L3	PL25B	7	LDQ23	C (LVDS)*	PL29B	7	LDQ27	C*	
J1	PL26A	7	LDQ23	T	PL30A	7	LDQ27	T	
GNDIO	GNDIO7	-			GNDIO7	-			
K2	PL26B	7	LDQ23	C	PL30B	7	LDQ27	C	
K1	PL28A	7	LUM1_SPLLT_IN_A/LDQ32	T (LVDS)*	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T*	
L1	PL28B	7	LUM1_SPLLC_IN_A/LDQ32	C (LVDS)*	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C*	
K8	PL29A	7	LUM1_SPLLT_FB_A/LDQ32	T	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T	
M5	PL29B	7	LUM1_SPLLC_FB_A/LDQ32	C	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	
VCCIO	VCCIO7	7			VCCIO7	7			
M4	PL30A	7	LDQ32	T (LVDS)*	PL34A	7	LDQ36	T*	
M3	PL30B	7	LDQ32	C (LVDS)*	PL34B	7	LDQ36	C*	
L8	PL31A	7	LDQ32	T	PL35A	7	LDQ36	T	
M6	PL31B	7	LDQ32	C	PL35B	7	LDQ36	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M1	PL32A	7	LDQS32	T (LVDS)*	PL36A	7	LDQS36	T*	
N1	PL32B	7	LDQ32	C (LVDS)*	PL36B	7	LDQ36	C*	
N3	PL33A	7	LDQ32	T	PL37A	7	LDQ36	T	
VCCIO	VCCIO7	7			VCCIO7	7			
N2	PL33B	7	LDQ32	C	PL37B	7	LDQ36	C	
N5	PL34A	7	LDQ32	T (LVDS)*	PL38A	7	LDQ36	T*	
N4	PL34B	7	LDQ32	C (LVDS)*	PL38B	7	LDQ36	C*	
M7	PL35A	7	PCLKT7_0/LDQ32	T	PL39A	7	PCLKT7_0/LDQ36	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M8	PL35B	7	PCLKC7_0/LDQ32	C	PL39B	7	PCLKC7_0/LDQ36	C	
P3	PL37A	6	PCLKT6_0	T (LVDS)*	PL41A	6	PCLKT6_0	T*	
P2	PL37B	6	PCLKC6_0	C (LVDS)*	PL41B	6	PCLKC6_0	C*	
P5	PL38A	6	VREF2_6	T	PL42A	6	VREF2_6	T	
N6	PL38B	6	VREF1_6	C	PL42B	6	VREF1_6	C	
P4	PL39A	6		T (LVDS)*	PL43A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
R3	PL39B	6		C (LVDS)*	PL43B	6		C*	
P6	PL40A	6		T	PL44A	6		T	
N7	NC	-			PL44B	6		C	
P1	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*	PL45A	6	LLM3_SPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
R1	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	PL45B	6	LLM3_SPLLC_IN_A	C*	
N8	PL42A	6	LLM2_SPLLT_FB_A	T	PL46A	6	LLM3_SPLLT_FB_A	T	
R5	PL42B	6	LLM2_SPLLC_FB_A	C	PL46B	6	LLM3_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL44A	6	LDQ48	T (LVDS)*	PL48A	6	LDQ52	T*	
T4	PL44B	6	LDQ48	C (LVDS)*	PL48B	6	LDQ52	C*	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L16	GND	-			GND	-			
L17	GND	-			GND	-			
L2	GND	-			GND	-			
L20	GND	-			GND	-			
L25	GND	-			GND	-			
L7	GND	-			GND	-			
M13	GND	-			GND	-			
M14	GND	-			GND	-			
N10	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N17	GND	-			GND	-			
P10	GND	-			GND	-			
P12	GND	-			GND	-			
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P17	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T2	GND	-			GND	-			
T20	GND	-			GND	-			
T25	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U16	GND	-			GND	-			
V22	GND	-			GND	-			
V5	GND	-			GND	-			
Y11	GND	-			GND	-			
Y16	GND	-			GND	-			
AB3	NC	-			NC	-			
AB4	NC	-			NC	-			
AC1	NC	-			NC	-			
AC2	NC	-			NC	-			
B4	NC	-			NC	-			
B5	NC	-			NC	-			
C26	NC	-			NC	-			
D20	NC	-			NC	-			
D21	NC	-			NC	-			
D22	NC	-			NC	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ2	LLC_SQ_HDINN3	14		C
AH4	LLC_SQ_VCCTX3	14		
AK5	LLC_SQ_HDOUTP3	14		T
AK4	LLC_SQ_VCCOB3	14		
AJ5	LLC_SQ_HDOUTN3	14		C
AH5	LLC_SQ_VCCTX2	14		
AJ6	LLC_SQ_HDOUTN2	14		C
AH6	LLC_SQ_VCCOB2	14		
AK6	LLC_SQ_HDOUTP2	14		T
AH2	LLC_SQ_VCCR2	14		
AJ3	LLC_SQ_HDINN2	14		C
AH3	LLC_SQ_VCCIB2	14		
AK3	LLC_SQ_HDINP2	14		T
AH7	LLC_SQ_VCCP	14		
AG7	LLC_SQ_REFCLKP	14		T
AF7	LLC_SQ_REFCLKN	14		C
AJ7	LLC_SQ_VCCAUX33	14		
AK11	LLC_SQ_HDINP1	14		T
AH11	LLC_SQ_VCCIB1	14		
AJ11	LLC_SQ_HDINN1	14		C
AH12	LLC_SQ_VCCR1	14		
AK8	LLC_SQ_HDOUTP1	14		T
AH8	LLC_SQ_VCCOB1	14		
AJ8	LLC_SQ_HDOUTN1	14		C
AH9	LLC_SQ_VCCTX1	14		
AJ9	LLC_SQ_HDOUTN0	14		C
AK10	LLC_SQ_VCCOB0	14		
AK9	LLC_SQ_HDOUTP0	14		T
AH10	LLC_SQ_VCCTX0	14		
AJ12	LLC_SQ_HDINN0	14		C
AJ13	LLC_SQ_VCCIB0	14		
AK12	LLC_SQ_HDINP0	14		T
AH13	LLC_SQ_VCCR0	14		
AF10	PB30A	5	BDQ33	T
AE8	PB30B	5	BDQ33	C
AE11	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5		
AD9	PB31B	5	BDQ33	C
AE10	PB32A	5	BDQ33	T
AD10	PB32B	5	BDQ33	C
AE13	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-		
AC12	PB33B	5	BDQ33	C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D19	PT93B	1		C
E18	PT93A	1		T
D18	PT92B	1		C
C17	PT92A	1		T
A17	PT91B	1		C
B17	PT91A	1		T
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
J18	PT75B	1		C
J19	PT75A	1		T
H17	PT74B	1		C
J17	PT74A	1		T
F18	PT73B	1		C
F17	PT73A	1		T
GNDIO	GNDIO1	-		
A16	PT72B	1		C
B16	PT72A	1		T
G17	PT71B	1		C
G16	PT71A	1		T
VCCIO	VCCIO1	1		
H16	PT70B	1		C
F16	PT70A	1		T
J16	PT69B	1		C
G15	PT69A	1		T
GNDIO	GNDIO1	-		
C16	PT68B	1		C
D16	PT68A	1		T
J15	PT67B	1		C
H15	PT67A	1		T
VCCIO	VCCIO1	1		
A15	PT66B	1	VREF2_1	C
B15	PT66A	1	VREF1_1	T
F15	PT65B	1	PCLKC1_0	C
E16	PT65A	1	PCLKT1_0	T
C15	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
D15	PT64A	0	PCLKT0_0	T
C14	PT63B	0	VREF2_0	C
E15	PT63A	0	VREF1_0	T
G14	PT62B	0		C
VCCIO	VCCIO0	0		
J14	PT62A	0		T
F14	PT61B	0		C

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO5	-			GNDIO5	-		
AE16	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C
AF15	PB44A	5	BDQ42	T	PB53A	5	BDQ51	T
VCCIO	VCCIO5	5			VCCIO5	5		
AD16	PB44B	5	BDQ42	C	PB53B	5	BDQ51	C
AK17	PB45A	5	BDQ42	T	PB54A	5	BDQ51	T
AH16	PB45B	5	BDQ42	C	PB54B	5	BDQ51	C
AN16	PB46A	5	BDQ42	T	PB55A	5	BDQ51	T
GNDIO	GNDIO5	-			GNDIO5	-		
AP16	PB46B	5	BDQ42	C	PB55B	5	BDQ51	C
AL17	PB47A	5	BDQ51	T	PB56A	5	BDQ60	T
AM17	PB47B	5	BDQ51	C	PB56B	5	BDQ60	C
AN17	PB48A	5	BDQ51	T	PB57A	5	BDQ60	T
AP17	PB48B	5	BDQ51	C	PB57B	5	BDQ60	C
AD17	PB49A	5	BDQ51	T	PB58A	5	BDQ60	T
AE17	PB49B	5	BDQ51	C	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
AL18	PB50A	5	BDQ51	T	PB59A	5	BDQ60	T
AM18	PB50B	5	BDQ51	C	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-			GNDIO5	-		
AP18	PB51A	5	BDQS51	T	PB60A	5	BDQS60	T
AN18	PB51B	5	BDQ51	C	PB60B	5	BDQ60	C
AG17	PB52A	5	VREF2_5/BDQ51	T	PB61A	5	VREF2_5/BDQ60	T
AJ17	PB52B	5	VREF1_5/BDQ51	C	PB61B	5	VREF1_5/BDQ60	C
AF17	PB53A	5	PCLKT5_0/BDQ51	T	PB62A	5	PCLKT5_0/BDQ60	T
AH17	PB53B	5	PCLKC5_0/BDQ51	C	PB62B	5	PCLKC5_0/BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AF18	PB58A	4	PCLKT4_0/BDQ60	T	PB67A	4	PCLKT4_0/BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AD18	PB58B	4	PCLKC4_0/BDQ60	C	PB67B	4	PCLKC4_0/BDQ69	C
AP19	PB59A	4	VREF2_4/BDQ60	T	PB68A	4	VREF2_4/BDQ69	T
AN19	PB59B	4	VREF1_4/BDQ60	C	PB68B	4	VREF1_4/BDQ69	C
AP20	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AM20	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C
AN20	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T
AM21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C
AG18	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AE18	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
AJ18	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T
AH18	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C
AK18	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AK19	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
AP21	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AN21	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AL20	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AK20	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C
AN22	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T
AL21	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AH19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T
AJ20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C
AD20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T
AF20	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
AJ19	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T
AH20	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C
AE20	PB73A	4	BDQ69	T	PB82A	4	BDQ78	T
AG20	PB73B	4	BDQ69	C	PB82B	4	BDQ78	C
GNDIO	GNDIO4	-			GNDIO4	-		
AH22	NC	-			PB89A	4	BDQ87	T
-	-	-			VCCIO4	4		
AH21	NC	-			PB89B	4	BDQ87	C
AG22	NC	-			PB90A	4	BDQ87	T
AG21	NC	-			PB90B	4	BDQ87	C
-	-	-			GNDIO4	-		
AM22	PB74A	4	BDQ78	T	PB92A	4	BDQ96	T
AL22	PB74B	4	BDQ78	C	PB92B	4	BDQ96	C
VCCIO	VCCIO4	4			VCCIO4	4		
AP23	PB77A	4	BDQ78	T	PB95A	4	BDQ96	T
AN23	PB77B	4	BDQ78	C	PB95B	4	BDQ96	C
GNDIO	GNDIO4	-			GNDIO4	-		
AM24	PB78A	4	BDQS78	T	PB96A	4	BDQS96	T
AL24	PB78B	4	BDQ78	C	PB96B	4	BDQ96	C
AK22	PB79A	4	BDQ78	T	PB97A	4	BDQ96	T
AJ22	PB79B	4	BDQ78	C	PB97B	4	BDQ96	C
AL23	PB80A	4	BDQ78	T	PB98A	4	BDQ96	T
AK23	PB80B	4	BDQ78	C	PB98B	4	BDQ96	C
VCCIO	VCCIO4	4			VCCIO4	4		
AJ23	PB81A	4	BDQ78	T	PB99A	4	BDQ96	T
AH23	PB81B	4	BDQ78	C	PB99B	4	BDQ96	C
GNDIO	GNDIO4	-			GNDIO4	-		
AL28	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13		
AM26	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T
AN26	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13		
AM27	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C
AN27	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13		
AP26	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T
AL26	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13		
AP27	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C
AN28	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13		
AP28	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C
AK28	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13		
AP29	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T

Date	Version	Section	Change Summary
November 2009 (cont.)	03.5 (cont.)	Pinout Information (cont.)	LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 table - corrected values for LFE2M50, 672 fpBGA in Available DDR-Interfaces per I/O Bank.
			Minor corrections in LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA table.
			Minor corrections in LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA table.
			Minor corrections in LFE2M100E/SE Logic Signal Connections: 900 fpBGA table.
			Updated LFE2-6E/SE and LFE2-12E/SE Logical Signal Connections (changed D1/SPIDS to D1).
		Ordering Information	Updated LatticeECP2M Part Number Description diagram.
March 2010	03.6	DC and Switching Characteristics	Footnote for SED operating frequency added to the sysCONFIG Port Timing Specifications table.
		Pinout Information	Changed Dual Function pin E7 to be D7/SPDI0 in Logic Signal Connections tables. Changed footnote (***) in Logic Signal Connections table.
July 2010	03.7	Architecture	Updated the Typical sysIO Behavior During Power-up text section.
		Pinout Information	Added reference to powerup information.
			Corrected reference to footnote for pins 131 and 132 for the LFE-20E/SE, 208 PQFP.
			Referenced footnote (***) for all D7/SPID0.
			Changed D7*** to D7/SPID0.
			Corrected *** footnote.
		All Sections	Included references to Lattice Diamond design software wherever ispLEVER and ispLeverCORE is specified.
April 2011	03.8	DC and Switching Characteristics	DC Electrical Characteristics table: - Added footnote 3 to I_{IH} - Added footnote 2 to I_{IL} , I_{IH} - Updated C1 and C2 typ. and max. data.
			DLL Timing table – Removed line for t_R and t_F
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added footnote to t_{DINIT} .
			Figure 3-18 – Corrected label to be PRGM (not PRGMRJ).
		Pinout Information	LFE2-12E/SE and LFE-20/SE Logical Signal Connections for 208 PQFP – Corrected Dual Function information for pins 112, 114, 117, 119.
January 2012	03.9	Multiple	Removed references to ispLEVER design software.
		Architecture	Corrected information regarding SED support.
		DC and Switching Characteristics	Added reference to ESD information.
June 2013	04.0	All	Updated document with new corporate logo.
		Architecture	Architecture Overview – Added information on the state of the register on power up and after configuration.

Date	Version	Section	Change Summary
June 2013 (cont.)	04.0 (cont.)	DC and Switching Characteristics	sysCLOCK SPLL Timing table – Corrected signal names for t_{RST} parameter.
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added t_{SUMCDI} and t_{HMCDI} parameters.
September 2013	04.1	Architecture	Updated Selectable Master Clock (CCLK) Frequencies during Configuration table.
		DC and Switching Characteristics	Added information on f_{MAXSPI} parameter in LatticeECP2/M sys-CONFIG Port Timing Specifications table.